

J657-VB Datasheet P-Channel 100 V (D-S) 175 °C MOSFET

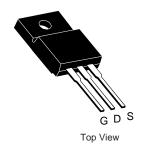
PRODUCT SUMMARY	
V _{DS} (V)	- 100
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.033
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.037
I _D (A)	- 50
Configuration	Single

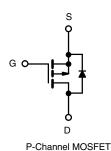
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- Package with Low Thermal Resistance
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC









ABSOLUTE MAXIMUM RATINGS	(T _C = 25 °C, unles	s otherwise noted	d)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V_{DS}	- 100	V	
Gate-Source Voltage	V _{GS}		± 20	V	
Continuous Drain Current	T _C = 25 °C	1	- 50		
Continuous Drain Current	T _C = 125 °C	Ι _D	- 30		
ntinuous Source Current (Diode Conduction)a		I _S	- 50	Α	
Pulsed Drain Current ^b		I _{DM}	- 180		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	- 44		
Single Pulse Avalanche Energy	L = 0.1 MH	E _{AS}	96	mJ	
Marrian Danier Dissipation	T _C = 25 °C	P _D	68	W	
Maximum Power Dissipation ^b	T _C = 125 °C	rD	35	VV	
Operating Junction and Storage Temperature I	Range	T _J , T _{stg}	- 55 to + 175	°C	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB Mount ^c	R_{thJA}	50	°C/W
Junction-to-Case (Drain)		R _{thJC}	1.1	C/ VV

Notes

- a. Package limited.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- c. When mounted on 1" square PCB (FR-4 material).
- d. Parametric verification ongoing.



PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					L	L	ı
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		- 100		-	\/
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = - 250 μA	- 1.0	-	-2.5	V
Gate-Source Leakage	I _{GSS}	V _{DS} =	$0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$	1	-	± 100	nA
Zero Gate Voltage Drain Current		$V_{GS} = 0 V$	V _{DS} = - 100 V	1	-	- 1	μΑ
	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = - 100 V, T _J = 125 °C	ı	-	- 50	
		$V_{GS} = 0 V$	V _{DS} = - 100 V, T _J = 175 °C	1	-	- 250	
On-State Drain Current ^a	I _{D(on)}	$V_{GS} = -10 \text{ V}$	$V_{DS} \le -5 \text{ V}$	- 30	-	-	Α
		V _{GS} = - 10 V	I _D = - 9.2 A	1	0.033	-	μA A Ω S PF nC Ω
Drain Course On State Besistance	R _{DS(on)}	$V_{GS} = -10 \text{ V}$	I _D = - 9.2 A, T _J = 125 °C	ı	0.074	-	
Drain-Source On-State Resistance ^a	¹ DS(on)	V _{GS} = - 10 V	I _D = - 9.2 A, T _J = 175 °C	ı	0.093	-	
		V _{GS} = - 4.5 V	$I_D = -7.7 \text{ A}$	ı	0.037	-	
Forward Transconductanceb	9 _{fs}	V _{DS} =	- 15 V, I _D = - 9.2 A	1	35	-	S
Dynamic ^b							
Input Capacitance	C _{iss}			1	4433	5545	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$	$V_{GS} = 0 \text{ V}$ $V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$	ı	301	380	pF
Reverse Transfer Capacitance	C _{rss}			1	208	260	
Total Gate Charge ^c	Q_{g}			1	96	144	
Gate-Source Charge ^c	Q_{gs}	$V_{GS} = -10 \text{ V}$	V _{DS} = - 50V, I _D = - 9.2 A	ı	8.4	-	nC
Gate-Drain Charge ^c	Q_{gd}			-	23.5	-	
Gate Resistance	R _g	f = 1 MHz		1.5	3.13	4.7	Ω
Turn-On Delay Time ^c	t _{d(on)}			-	11	17	
Rise Time ^c	t _r	$V_{DD} = -50 \text{ V}, R_L = 6.49 \Omega$		-	11	17	-
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -7.7 \text{ A}, $	$V_{GEN} = -10 \text{ V}, R_g = 1.0 \Omega$	-	78	117	IIS
Fall Time ^c	t _f	7		-	15	23	
Source-Drain Diode Ratings and Chara	acteristics ^b						
Pulsed Current ^a	I _{SM}			-	-	- 150	Α
Forward Voltage	V_{SD}	lr = ·	- 7.7 A, V _{GS} = 0 V	_	- 0.8	- 1.5	V

Notes

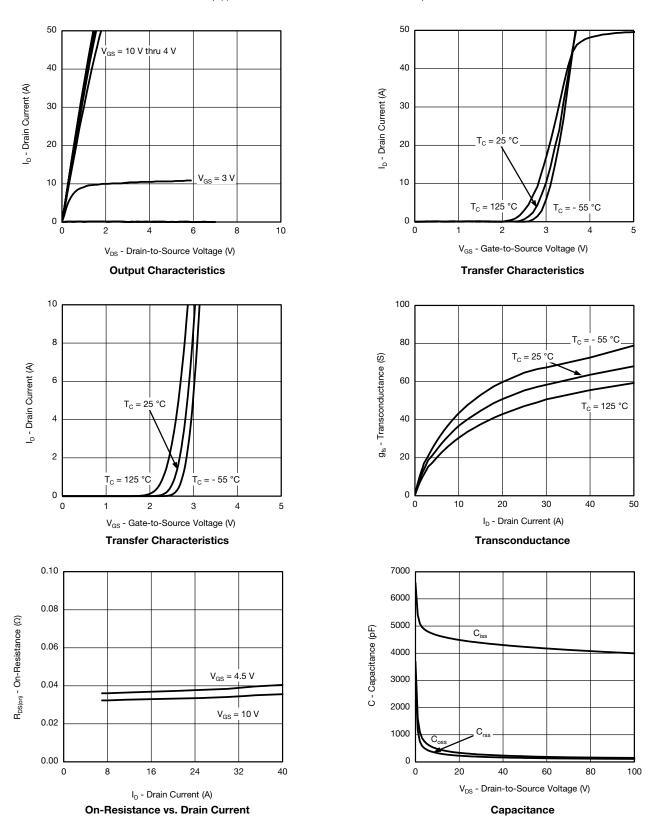
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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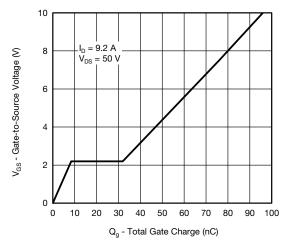


TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

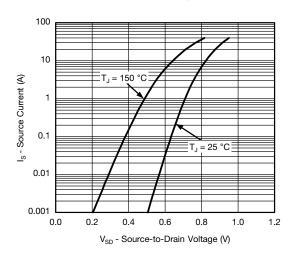




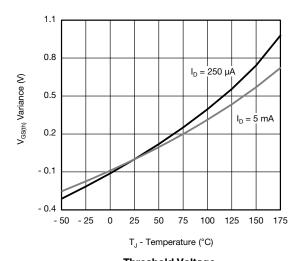
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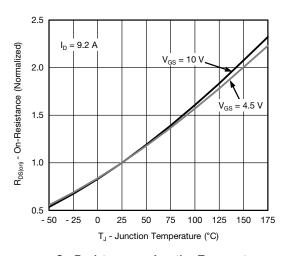
Gate Charge



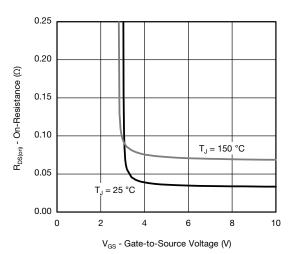
Source Drain Diode Forward Voltage



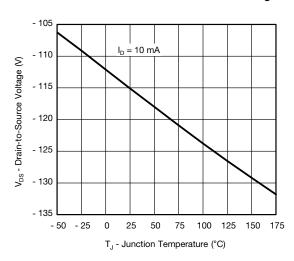
Threshold Voltage



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

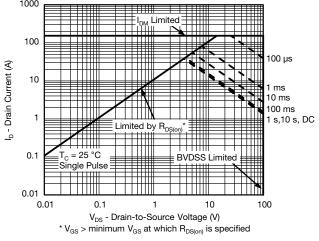


Drain Source Breakdown vs. Junction Temperature

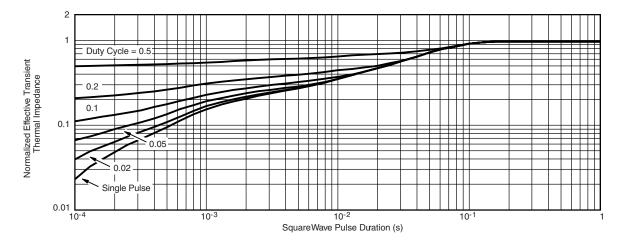
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THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



Safe Operating Area

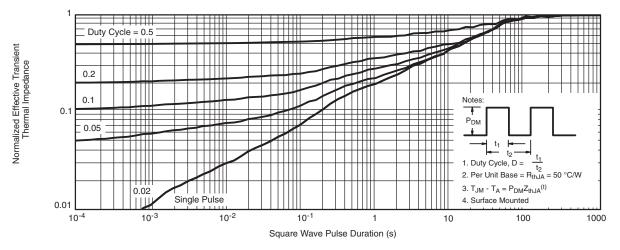


Normalized Thermal Transient Impedance, Junction-to-Case

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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

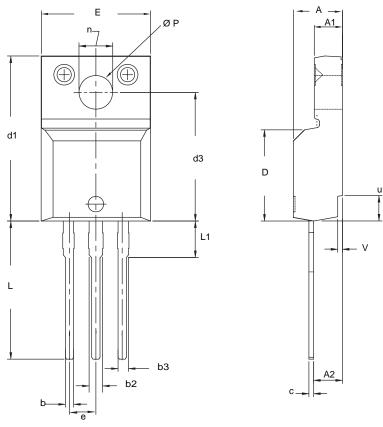
Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction to Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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TO-220 FULLPAK



MIN.	MAX.	MIN.	B4 4 3/
		IVIIIV.	MAX.
4.570	4.830	0.180	0.190
2.570	2.830	0.101	0.111
2.510	2.850	0.099	0.112
0.622	0.890	0.024	0.035
1.229	1.400	0.048	0.055
1.229	1.400	0.048	0.055
0.440	0.629	0.017	0.025
8.650	9.800	0.341	0.386
15.88	16.120	0.622	0.635
12.300	12.920	0.484	0.509
10.360	10.630	0.408	0.419
2.54 BSC		0.100 BSC	
13.200	13.730	0.520	0.541
3.100	3.500	0.122	0.138
6.050	6.150	0.238	0.242
3.050	3.450	0.120	0.136
2.400	2.500	0.094	0.098
0.400	0.500	0.016	0.020
	2.510 0.622 1.229 1.229 0.440 8.650 15.88 12.300 10.360 2.54 13.200 3.100 6.050 3.050 2.400	2.510 2.850 0.622 0.890 1.229 1.400 1.229 1.400 0.440 0.629 8.650 9.800 15.88 16.120 12.300 12.920 10.360 10.630 2.54 BSC 13.200 13.730 3.100 3.500 6.050 6.150 3.050 3.450 2.400 2.500 0.400 0.500	2.510 2.850 0.099 0.622 0.890 0.024 1.229 1.400 0.048 1.229 1.400 0.048 0.440 0.629 0.017 8.650 9.800 0.341 15.88 16.120 0.622 12.300 12.920 0.484 10.360 10.630 0.408 2.54 BSC 0.100 13.200 13.730 0.520 3.100 3.500 0.122 6.050 6.150 0.238 3.050 3.450 0.120 2.400 2.500 0.094 0.400 0.500 0.016

Notes

- To be used only for process drawing.
 These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads.
 All critical dimensions should C meet C_{pk} > 1.33.
 All dimensions include burrs and plating thickness.
 No chipping or package damage.

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